NOTES:
1.MATERIAL:
HOUSING: THERMOPLASTIC SEE PART NO. DESCRIPTION.
CONTACT: COPPER ALLOY.
SHIELD: SUS.
2.FINISH:
CONTACT: GOLD PLATING ON CONTACT AREA
50μ" TIN PLATING ON SOLDER TAIL,
30μ" NICKEL UNDER PLATING OVER ALL.
SHIELD: 30μ" NICKEL PLATING.
3. PART NO. DESCRIPTION:

UC X F 0 1 1 6 X - X X - X X - X

SHELL PLATED
N: NICKEL

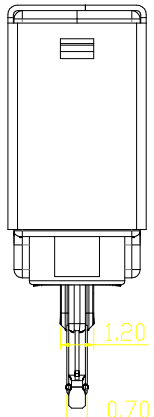
CONTACT PLATED
C: 30u" Au WITH MATTE-TIN
3: 30u" Au WITH BRIGHT-TIN
A: G/F Au WITH MATTE-TIN
1: G/F Au WITH BRIGHT-TIN

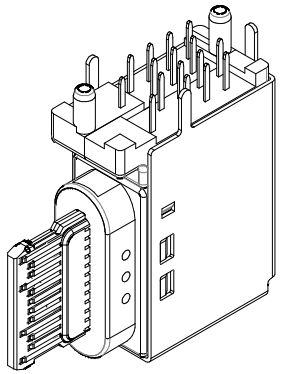
HOUSING MATERIAL
G: PA46 UL94 V-0

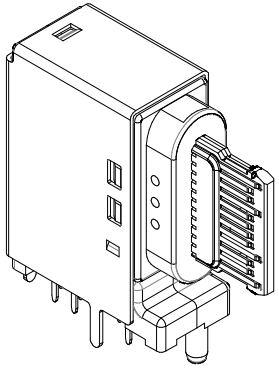
HOUSING COLOR
0:White

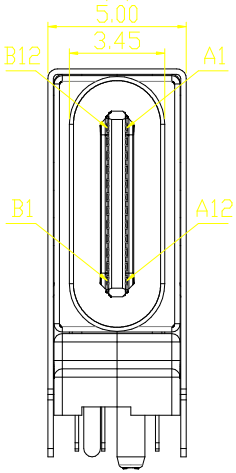
PACKAGE
0:TRAY
2:REEL

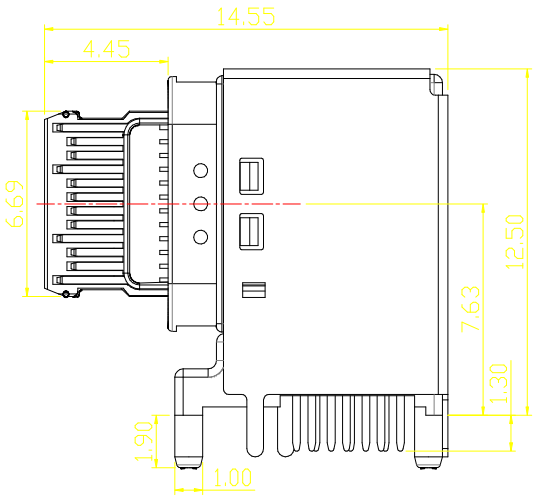
A:REV.
0:MARK

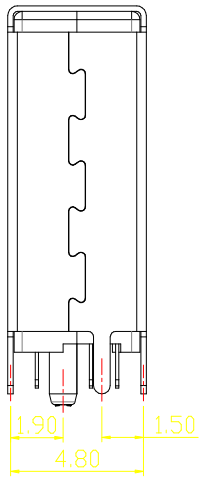


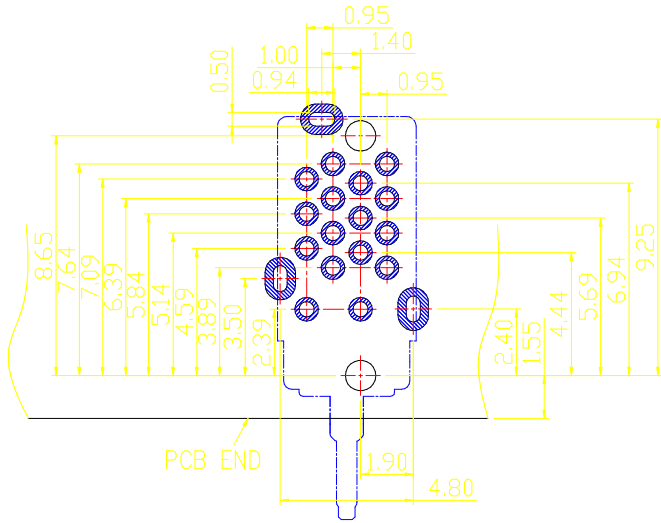


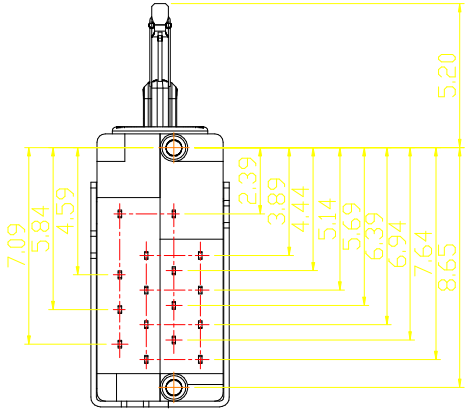


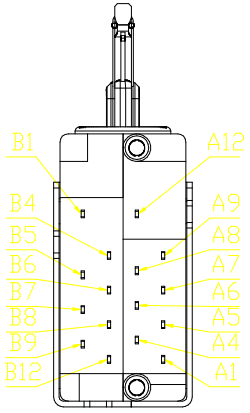












RECOMMEND P.C.B LAYOUT (THICKNESS=1.0mm)
(COMPONENT SIDE) TOLERANCE±0.02

深圳市虹康科技有限公司

PART No.:	MOLD No.: NA	SUPPLIER: NA	TITLE: USB C FLAG TYPE CH 7.63mm
TOLERANCES: .X ± 0.35 X. °±3° .XX± 0.25 X.X°±2°	CAV. No.: 1~1 1~2 1~16 A~P ○ 其它	APPD: Weison 2016/06/07 CHKD: Chen Lin 2016/06/07 DR: Wu Gang 2016/06/07	DWG NO.: SHK-31022
			SCALE: 1:1 SHEET: 1 OF 1

REVISED: ECN: DRWN: CHKD: APPR:
NEW RELEASE ECN: DRWN: Weison 2016/06/07 CHKD: Chen Lin 2016/06/07 APPR: Wu Gang 2016/06/07
REV: A0 DESCRIPTION:

REV. A 2015/05/01